

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1245	174/254.ccls.	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:01
L2	12	1 and flexible adj wiring adj substrate or FWB and insulating adj substrate	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:14
L3	822	flexible adj wiring adj substrate or FWB and insulating adj substrate	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:15
L4	2	3 and wiring adj pattern and solder adj resist adj layer and tin adj plating adj layer	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:17
L5	10	wiring adj pattern and solder adj resist adj layer and tin adj plating adj layer and flexible adj wiring adj substrate or FWB and insulating adj substrate	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:19

L6	814	flexible adj wiring adj substrate or FWB and insulating adj substrate and wiring adj pattern and solder adj resist adj layer and tin adj plating adj layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:20
L14	113	Insulating adj substrate and wiring adj pattern and solder and wiring adj pattern and wiring adj pattern same multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:29
L15	17	Insulating adj substrate and wiring adj pattern and solder and wiring adj pattern and wiring adj pattern same multilayer and solder adj resist adj layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:30
L16	9	Insulating adj substrate and wiring adj pattern and solder and wiring adj pattern and wiring adj pattern same multilayer and solder adj resist adj layer and plating adj layer and	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:31

		multilayer					
L17	1	Insulating adj substrate and wiring adj pattern and solder and wiring adj pattern and wiring adj pattern same multilayer and solder adj resist adj layer and plating adj layer and multilayer and copper adj layer	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/07 14:32	

4/7/2008 3:39:36 PM

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